

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







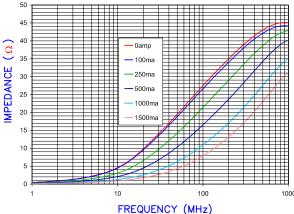
MI0603K300R-10

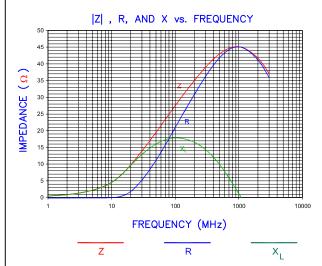
UNCONTROLLED DOCUMENT

PHYSICAL DIMENSIONS:

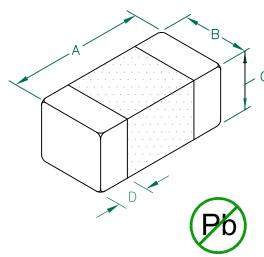
Α	1.60	[.063]	- 0.15	[.006]
В	0.80	[.031]	± 0.15	[.006]
С	0.80	[.031]	± 0.15	[.006]
D	0.36	[014]	+ 0.15	[006]

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS





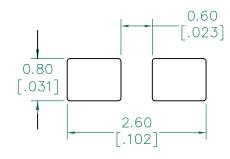
AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3298



NOTES: UNLESS OTHERWISE SPECIFIED

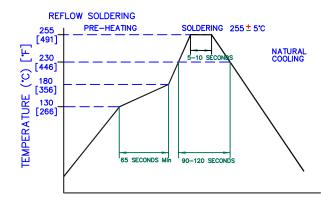
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [.030] to this dimension)

RECOMMENDED SOLDERING CONDITIONS





		DIMENSIONS ARE IN mm [INCHE		This print is the property of Laird							
					Tech. and is loaned in confidence subject to return upon request and with the understanding that no copies shall be made without the			Laird			
					written consent of Laird Tech. All rights to design or invention are reserved.						
	D	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	PROJECT/PART NUMBER:	RE	v D	PART TYPE: CO-FIRE		DRAWN BY:	
- 1	С	UPDATE COMPANY LOGO	07/25/08	JRK	MI0603K300R-10		_	CO-PIRE		IMB	
	В	CORRECT REF # FROM 3289 TO 3298	07/22/05	JRK	DATE: 04/05/04 St	CALE:		_	SHEET:		
	Α	ORIGINAL DRAFT	04/05/04	ТМВ					2	of 2	
	REV	DESCRIPTION	DATE	INT			<u> </u>			· -	